

# PRM017N04S8

# **PFC Device Corporation**

# **40V Single N-Channel MOSFET**

## Major ratings and characteristics

Characteristics	Characteristics Values	
$V_{DS}$	40	V
I <sub>D</sub> (T <sub>A</sub> =25°C)	9.3	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	17	mΩ
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =4.5V	22	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°C

# **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

# PRM017N04S8 DDDDD SSP-8

# **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

### **Features**

- Max.  $R_{DS(ON)}=17m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

# 1. Characteristics

**Maximum Ratings Characteristics** 

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	±20	V
	Drain Current – Continuous (T <sub>A</sub> =25°C)	9.3	А
<b>I</b> D	Drain Current – Continuous (T <sub>A</sub> =100°C)	5.8	А
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	36	А
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	9.8	mJ
$I_{AS}$	Single Pulse Avalanche Current <sup>2</sup>	14	А
Ъ	Power Dissipation (T <sub>A</sub> =25°C)	2.5	W
$P_D$	Power Dissipation – Derate above 25°C	0.02	W/°C
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		50	°C/W



Version 4.1 2 / 8

### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_D$ =250uA	40			V
	Drain Source Leekage Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			250	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA

### On Characteristics

D	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =5A			17	mΩ
$R_{DS(ON)}$		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A	-	-	22	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=250uA$	1.0		2.5	V
$g_{\sf fs}$	Forward Transconductance	$V_{DS}$ =5V, $I_{D}$ =5A	-	16		S

**Dynamic and switching Characteristics** 

$Q_g$	Total Gate Charge <sup>3, 4</sup>		 15.5	
$Q_gs$	Gate-Source Charge <sup>3,4</sup>	$V_{DS}$ =20V, $V_{GS}$ =10V, $I_{D}$ =9.3A	 2.5	 nC
$Q_gd$	Gate-Drain Charge <sup>3, 4</sup>		 3	
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>		 7.1	
T <sub>r</sub>	Turn-On Rise Time <sup>3, 4</sup>	$V_{DD}$ =20V, $V_{GS}$ =10V, $R_{G}$ =6 $\Omega$	 29	 ns
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>	I <sub>D</sub> =9.3A	 19	 115
$T_f$	Turn-Off Fall Time <sup>3, 4</sup>		 22	
$C_{iss}$	Input Capacitance		 880	
$C_{oss}$	Output Capacitance	$V_{DS}$ =25V, $V_{GS}$ =0V, f=1MHz	 80	 pF
$C_{rss}$	Reverse Transfer Capacitance		 65	
$R_{g}$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz	 2.4	 Ω

### **Drain-Source Diode Characteristics**

Table 1000100 to Brain Blodd Voltago		$V_{SD}$	Source to Drain Diode Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =9.3A			1.5	V
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### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2.  $V_{DD}$ =50V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =14A,  $R_{G}$ =25 $\Omega$ , Starting  $T_{J}$ =25 $^{\circ}$ C
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.
- 4. Essentially independent of operating temperature.

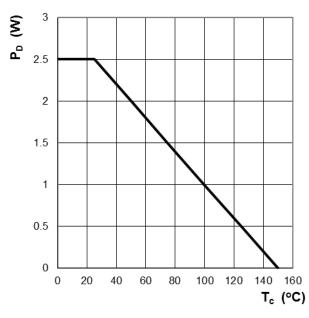


Version 4.1 3 / 8

# 2. Characteristics Curves

# **Ratings and Characteristics Curves**

# (T<sub>A</sub> = 25°C unless otherwise specified)



10 ₹ 9 \_ 8 7 6 5 4 3 2 0 50 75 100 125 150 T<sub>c</sub> (°C)

**Figure 1: Power Dissipation** 

Figure 2: Continuous Drain Current vs. T<sub>C</sub>

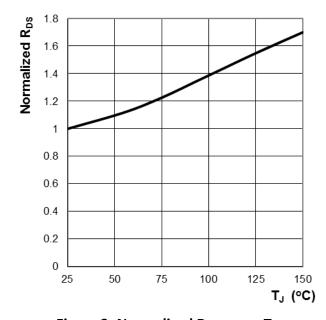


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

Figure 4: Normalized BV<sub>DSS</sub> vs. T<sub>J</sub>



Version 4.1 4 / 8

### **Ratings and Characteristics Curves**

# ( T<sub>A</sub> = 25° unless otherwise specified )

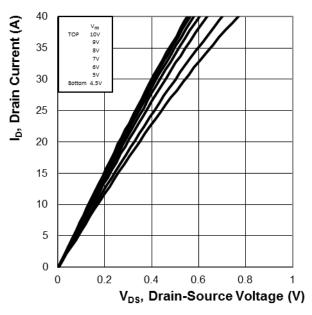


Figure 5: On-Region Characteristics

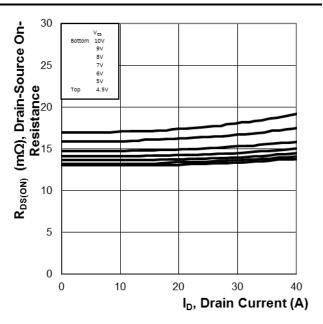


Figure 6: Typ. R<sub>DS</sub> Variation vs. I<sub>D</sub> and V<sub>GS</sub>

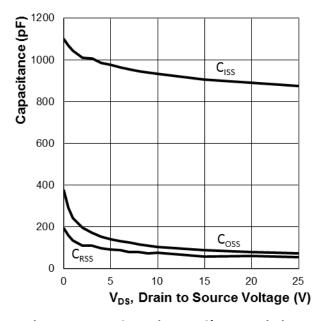
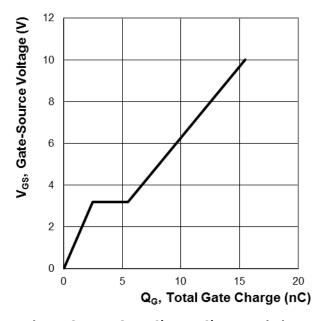


Figure 7: Typ. Capacitance Characteristics



**Figure 8: Typ. Gate Charge Characteristics** 



Version 4.1 5 / 8

Characteristics PRM017N04S8

### **Ratings and Characteristics Curves**

( T<sub>A</sub> = 25°C unless otherwise specified )

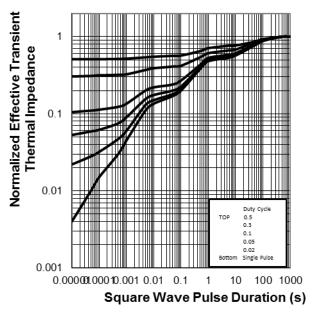


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

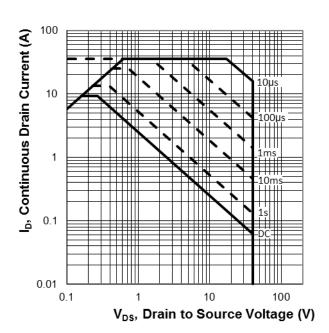


Figure 10: Maximum Safe Operation Area



Version 4.1 6 / 8

# 3. Marking information

**Top Marking Rule** 

PFC PRM 017N04S8 YYWW ABSH

PRM017N04S8 = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

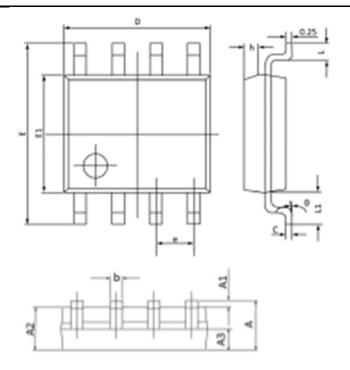
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

# 4. Package information

# Package Outline Dimensions millimeters



Dim. Min. Max.					
A	1.35 1.75				
Al	0.10 0.25				
A2	1.30				
A3	0.60	0.70			
b	0.35	0.49			
c	0.18	0.26			
D	4.70 5.10				
E	5.80	6.20			
E1	3.70 4.10				
e 1.27 BSC					
h	0.25	0.50			
L	0.40 0.90				
Ll	1.05 BSC				
θ	0°	8°			
All Dimensions in mm					



Version 4.1 7 / 8

# 5. Ordering information

Part Number	Package	Delivery mode
PRM017N04S8	SOP-8	3000 pcs / 13" diameter reel

### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.003 ounces (0.085grams) – SOP-8

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Version 4.1 8 / 8